

C1812X472KDGACTU

Aliases (C1812X472KDGAC7800) SMD Comm COG HV Flex, Ceramic, 4,700 pF, 10%, 1,000 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1812, 2.3 mm



General Information	
Series	SMD Comm COG HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra- Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	87 mg
Shelf Life	78 Weeks
MSL	1

Dimens	sions	
Chip Siz	ze	1812
L		4.5mm +/-0.4mm
W		3.2mm +/-0.3mm
т		2.5mm +/-0.20mm
S		2.3mm MIN
в		0.7mm +/-0.35mm

Packaging Specifications

PackagingT&R, 180mm, Plastic TapePackaging Quantity500

Specifications	
Capacitance	4,700 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	1000 VDC
Dielectric Withstanding Voltage	1,200 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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